(12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(19) World Intellectual Property Organization International Bureau



(43) International Publication Date 30 October 2003 (30.10.2003)

(10) International Publication Number WO 03/089513 A1

(51) International Patent Classification7: 71/02, 55/02, C08K 5/521, C08L 25/10 C08L 25/06,

(21) International Application Number: PCT/KR03/00749

14 April 2003 (14.04.2003) (22) International Filing Date:

(25) Filing Language:

Korean

(26) Publication Language:

English

(30) Priority Data: 10-2002-0020639

16 April 2002 (16.04.2002)

(71) Applicant (for all designated States except US): CHEIL INDUSTRIES INC. [KR/KR]; 290 Gongdan-dong, Gumi-si, Gyeongsangbuk-do 730-710 (KR).

(72) Inventors; and

(75) Inventors/Applicants (for US only): AHN, Sung Hee [KR/KR]; 102-503 Kumho-bestville, 1052 Sangwangsimni-dong, Seongdong-gu, Seoul 133-010 (KR). YANG, Jae Ho [KR/KR]; 981-1205 Bakdu Apt., 1119 Sanbon-dong, Euiwang-si, Gyeonggi-do 435-040 (KR). JANG, Young Gil [KR/KR]; 141-94 Sadang3-dong, Dongjak-gu, Seoul 156-093 (KR). BAE, Su Hak [KR/KR]; Hyundai Apt. 101-810, Seongsu2-dong, Seongdong-gu, Seoul 133-112 (KR).

- (74) Agent: CHOI, Duk Kyu; 5th Floor Chunwoo Bldg., 736 Yoksam-dong, Gangnam-gu, Seoul 135-080 (KR).
- (81) Designated States (national): AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NO, NZ, OM, PH, PL, PT, RO, RU, SD, SE, SG, SK, SL, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, YU, ZA, ZM, ZW.
- (84) Designated States (regional): ARIPO patent (GH, GM, KE, LS, MW, MZ, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian patent (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European patent (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IT, LU, MC, NL, PT, RO, SE, SI, SK, TR), OAPI patent (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).

Published:

with international search report

For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.

(54) Title: THERMOPLASTIC FLAME RETARDANT RESIN COMPOSITIONS

(57) Abstract: A thermoplastic flame retardant resin composition according to the present invention comprises: (A) about 40~95 parts by weight of a styrenic resin; (B) about 5-60 parts by weight of a polyphenylene ether; (C) about 0.1-40 parts by weight of a rubber modified polystyrene resin containing about 40~65 % by weight of a rubber and about 0.1~8 % by weight of acrylonitrile based on 100 parts by weight of the sum of (A) and (B); and (D) about 5 to 30 parts by weight of an aromatic phosphoric acid ester compound based on 100 parts by weight of the sum of (A) and (B).

WO 03/089513

PCT/KR03/00749

THERMOPLASTIC FLAME RETARDANT RESIN COMPOSITIONS

Field of the Invention

5

The present invention relates to a thermoplastic flame retardant resin composition. More particularly, the present invention relates to a thermoplastic flame retardant resin that comprises a styrenic resin and polyphenylene ether as a base resin, a rubber modified polystyrene resin containing 0.1-8 % by weight of acrylonitrile in the polystyrene resin excluding rubber, and an aromatic phosphoric acid ester as a flame retardant.

Background of the Invention

15

20

10

Polyphenylene ether resin has good thermal resistance, high impact strength, and good dimensional stability. Accordingly, the resin has been widely applied for common uses. However, the disadvantage could be observed that the polyphenylene ether resin has poor processability due to its excessively high thermal resistance. For this reason, the polyphenylene ether resin is blended with a rubber-modified styrenic resin or a styrenic resin to improve processability for use of electronic appliances such as personal computers, facsimiles, and the like. Further, in case that a blend of a polyphenylene ether and a rubber modified styrene-containing resin is applied to the fields of electric or electronic goods, flame-retardant property should be given to the resin.

25

30

A widely known method for giving the flame retardant property is that a halogen-containing compound or an antimony-containing compound is added to a rubber modified styrene-containing resin. However, the disadvantages could be observed that the halogen-containing compound results in the corrosion of the mold itself by the hydrogen halide gases released during the molding process and is fatally harmful due to the toxic gases liberated in case of fire.

Especially, since polybromodiphenyl ether, mainly used for a halogen containing flame retardant, can produce toxic gases such as dioxin or furan during combustion, flame-retardants that are prepared without a halogen-containing compound have become a major concern in this field.

It is commonly a known method to apply a phosphorus or nitrogen compound as halogen-free flame retardant to a resin composition. However, usage of only a phosphorus compound deteriorates heat resistance of a rubber modified styrene-containing resin and does not impart sufficient flame retardant property.

5

10

15

20

25

30

Generally, when a rubber modified styrene-containing resin such as ABS is burned; a char is not produced due to decomposition and vaporization in most parts (*Journal of Applied Polymer Science*, 1998, vol 68, p1067). Therefore, to impart an effect of flame retardancy, it is necessary to add a char-forming agent such as polycarbonate or polyphenylene ether resin to a resin composition, which plays a role in prohibiting entrance of oxygen and emission of fuel by forming char on the surface of rubber with three-dimensional carbon bonds under combustion.

Aromatic phosphoric ether is commonly used to give the flame retardancy to the blend.

Japanese Patent Laid-open No. 7-48491 discloses a flameproof thermoplastic resin, made of adding a novolac phenolic resin as a char-forming agent and a phosphoric acid ester as a flame retardant into a thermoplastic copolymer resin composed of a rubber copolymer and an aromatic vinyl monomer. It was found that in order to obtain a good property of flame retardancy, a phenolic resin as a char-forming agent and a phosphoric acid ester compound as a flame retardant should be added in a lot of amount. However, in this case, the heat resistance of the resin composition is dropped suddenly.

In a blend of a polyphenylene ether and a rubber modified styrene-containing resin, the more the rubber modified styrene-containing resin is used, the lower the flame retardancy of the resin composition is getting. Thus, flame retardancy is almost lost when the rubber modified polystyrene is added more than the critical amount. If the amount of acrylonitrle-butadiene-styren copolymer

or rubber modified polystyrene resin is increased in the blend of a polyphenylene ether and a rubber modified styrene-containing resin, a great amount of decomposition is produced from combustion, so that a char film is destroyed to decrease flame retardancy of the resin.

U.S. patent No. 3,639,506 discloses a resin composition using triphenyl phosphate (TPP) and a halogen-containing compound together as flame retardants for giving flame retardancy to a polyphenylene ether resin and a stryrenic resin. U.S. patent No. 3,883,613 discloses a resin composition using trimesityl phosphate as a flame retardant to a polyphenylene ether resin and a stryrenic resin. U.S. patent No. 4,526,917 discloses a resin composition using TPP and trimesityl phosphate as flame retardants.

Accordingly, the present inventors have developed a thermoplastic flame retardant resin composition which has a good appearance, flame-retardancy, and impact strength by adding acrylonitrile-rubber-styrene copolymer containing 0.1 to 8 % by weight of acrylonitrile in the polystyrene resin excluding rubber to a blend of a rubber modified polystyrene resin and polyphenylene ether resin.

Objects of the Invention

An object of the present invention is to provide a thermoplastic resin composition with good flame retardancy.

Another object of the present invention is to provide a thermoplastic flame retardant resin composition with good appearance and gloss.

A further object of the present invention is to provide a thermoplastic flame retardant resin composition with good impact strength.

A further object of the present invention is to provide a thermoplastic flame retardant resin composition with good molding property.

Other objects and advantages of this invention will be apparent from the ensuing disclosure and appended claims.

25 '

5

10

15

20

Summary of the Invention

A thermoplastic flame retardant resin composition according to the present invention comprises (A) about 40 to 95 parts by weight of a styrenic resin; (B) about 5 to 60 parts by weight of a polyphenylene ether; (C) about 0.1 to 40 parts by weight of a rubber modified polystyrene resin containing about 40 to 65 % by weight of a rubber and about 0.1 to 8 % by weight of acrylonitrile in the polystyrene resin excluding rubber based on 100 parts by weight of the sum of (A) and (B); and (D) 5 to 30 parts by weight of an aromatic phosphoric acid ester compound based on 100 parts by weight of the sum of (A) and (B).

The detailed descriptions of components of the resin composition according to the present invention are as follows:

Detailed Description of the Invention

15

20

25

10

5

(A) Styrenic Resin

The styrenic resin of the present invention is prepared by a known method such as bulk polymerization, suspension polymerization, emulsion polymerization, or a combination thereof. In the present invention, polystyrene resin without rubber and rubber modified polystyrene resin can be used alone or in combination as a mixture.

The rubber modified polystyrene resin can be produced by thermal polymerization without an initiator, or in the presence of initiator such as benzoyl peroxide, t-butyl hydroperoxide, acetyl peroxide, cumen hydroperoxide, etc, by adding 80 to 99.5 parts by weight of one or more monomer(s) selected from a group consisting of styrene, N-substituted styrene and α -alkyl styrene to 0.5 to 20 parts by weight of a rubber selected from the group consisting of butadiene, isoprene, copolymer of butadiene and styrene, and alkyl acrylate.

The polystyrene resin without rubber can be prepared by thermal polymerization without an initiator, or in the presence of an initiator such as benzoyl peroxide, t-butyl hydroperoxide, acetyl peroxide, or cumen hydroperoxide, by polymerizing one or more monomer(s) selected from the group consisting of styrene, N-substituted styrene and α -alkyl styrene.

Preferably, the styrenic resin of the present invention is used in an amount of about 40 to 95 parts by weight, and more preferably 50 to 90 parts by weight.

(B) Polyphenylene Ether Resin

10

15

5

The Polyphenylene ether resin is employed as a base resin to improve flame retardancy, heat resistance and rigidity of the resin composition according to the present invention. As examples of the polyphenylene ether resin, poly(2,6-dimethyl-1,4-phenylene) ether, poly(2,6-diethyl-1,4-phenylene) ether, poly(2,6-dipropyl-1,4,-phenylene) ether, poly(2-methyl-6-ethyl-1,4-phenylene) ether, poly(2-methyl-6-propyl-1,4-phenylene) ether, poly(2-ethyl-6-propyl-1,4-phenylene) ether, poly(2,6-diphenyl-1,4-phenylene) ether, copolymer of poly (2,6-dimethyl-1,4-phenylene) ether and poly(2,3,6-trimethyl-1,4-phenylene) ether, and copolymer of poly(2,6-dimethyl-1,4-phenylene) ether and poly(2,3,5-triethyl-1,4-phenylene) ether can be used.

20

Preferably, copolymer of poly(2,6-dimethyl-1,4-phenylene) ether and poly(2,3,6-trimethyl-1,4-phenylene) ether, and poly(2,6-dimethyl-1,4-phenylene) ether are preferably used, more preferably poly(2,6-dimethyl-1,4-phenylene) ether is used.

25

The degree of polymerization of polyphenylene ether is not limited specifically, but considering heat-stability or processability of the resin composition, it is preferable that the intrinsic viscosity of polyphenylene ether is in the range of from 0.2 to 0.8 when measured in a chloroform solvent at 25 $^{\circ}$ C.

The polyphenylene ether resin in this invention is preferably used in an

amount of 5 to 60 parts by weight, more preferably 10 to 50 parts by weight.

(C) Rubber modified polystyrene resin containing about 0.1 to 8 % by weight of acrylonitrile in the polystyrene resin excluding rubber

5

10

15

20

25

The rubber modified polystyrene resin according to the present invention is a graft copolymer wherein rubber phase polymers are dispersed in the form of particles in a matrix obtained by graft-polymerizing monomer mixture onto rubber phase polymer. The rubber modified polystyrene resin is prepared by mixing an aromatic vinyl monomer and a vinyl group-containing monomer, which can be copolymerized therewith, in the presence of a rubbery phase polymer.

Such rubber-modified styrenic resin is prepared by a known method such as emulsion polymerization, suspension polymerization or bulk polymerization. In bulk polymerization, the grafted copolymer can be produced in one process. The content of rubber in the final rubber modified polystyrene resin to the total weight of a graft copolymer resin is preferably in 40 to 65 % by weight. The examples of such resins are acrylonitrile-butadiene-styrene (ABS) copolymer resin, acrylonitrile-acryl rubber-styrene (AAS) copolymer resin, acrylonitrile-ethylenepropylene rubber- styrene copolymer resin, and so on.

The examples of the rubber for rubber-modified styrenic resin are diene rubbers such as polybutadiene, poly(styrene-butadiene), poly(acrylonitrile-butadiene), etc; a saturated rubber in which hydrogen is added to said diene-containing rubber; isoprene rubber; chloroprene rubber; a polyacrylic acid butyl; and a terpolymer of ethylene-propylene-diene (EPDM). It is preferable to use a diene-containing rubber, more preferably a butadiene-containing rubber. The content of rubber is preferably in the range of 40 to 65 % by weight based on the total weight of a graft copolymer resin.

The examples of the aromatic vinyl monomer are styrene, α -methyl styrene,

p-methyl styrene, etc. In the above examples, styrene is the most preferable.

The examples of the vinyl group-containing monomer copolymerizable with aromatic vinyl monomer are cyanide vinyl group-containing compounds such as acrylonitrile and unsaturated nitrile-containing compounds such as methacrylonitrile.

In the present invention, the rubber modified polystyrene resin is composed of 40 to 65 % by weight of rubber and 60 to 35 % by weight of monomer mixture. The monomer mixture contains 92 to 99.9 % by weight of aromatic vinyl monomer such as styrene and 0.1 to 8 % by weight of unsaturated nitrile monomer. It is preferable that the monomer mixture contains 95 to 99.9 % by weight of aromatic vinyl monomer and 0.1 to 5 % by weight of unsaturated nirtile monomer.

In addition, in order to give good characteristics of processability and heat resistance, the monomers such as acrylic acid, methacryl acid, maleic anhydride and N-substituted maleimide can be added in the graft polymerization. The amounts of the monomers are less than 40 parts by weight based on 100 parts by weight of the graft copolymer resin.

To acquire good impact strength and appearance when said styrene-containing graft copolymer is prepared, the average size of rubber particles is preferably in the range of from 0.1 to 0.4 μ m.

The content of the rubber modified polystyrene resin in the present invention is preferably 0.1 to 40 parts by weight per 100 parts by weight of the base resin. It is more preferable that the content of the rubber modified polystyrene resin is more preferably 10 to 40 parts by weight per 100 parts by weight of the base resin

(D) Phosphoric acid ester compound

5

10

15

20

25

The phosphoric acid ester compound used in the present invention is a compound having the following structural formula (I):

WO 03/089513

$$R_{2} \xrightarrow{R_{1}} O \xrightarrow{0} A \xrightarrow{0} A \xrightarrow{R_{3}} R_{2}$$

$$R_{3} \xrightarrow{R_{1}} R_{3} \xrightarrow{R_{3}} R_{1} \xrightarrow{R_{2}} R_{3}$$

$$R_{2} \xrightarrow{R_{2}} R_{2}$$

$$R_{3} \xrightarrow{R_{1}} R_{3} \xrightarrow{R_{3}} R_{1} \xrightarrow{R_{3}} R_{2}$$

$$R_{1} \xrightarrow{R_{2}} R_{3} \xrightarrow{R_{3}} R_{1} \xrightarrow{R_{3}} R_{2}$$

$$R_{2} \xrightarrow{R_{3}} R_{3} \xrightarrow{R_{3}} R_{1} \xrightarrow{R_{3}} R_{2}$$

$$R_{3} \xrightarrow{R_{1}} R_{3} \xrightarrow{R_{3}} R_{1} \xrightarrow{R_{3}} R_{3}$$

$$R_{1} \xrightarrow{R_{3}} R_{2} \xrightarrow{R_{3}} R_{3}$$

$$R_{2} \xrightarrow{R_{3}} R_{3} \xrightarrow{R_{3}} R_{3}$$

$$R_{3} \xrightarrow{R_{3}} R_{3} \xrightarrow{R_{3}} R_{3}$$

$$R_{4} \xrightarrow{R_{3}} R_{3} \xrightarrow{R_{3}} R_{3}$$

$$R_{5} \xrightarrow{R_{3}} R_{3} \xrightarrow{R_{3}} R_{3}$$

$$R_{5} \xrightarrow{R_{3}} R_{3} \xrightarrow{R_{3}} R_{3}$$

$$R_{1} \xrightarrow{R_{3}} R_{3} \xrightarrow{R_{3}} R_{3}$$

$$R_{2} \xrightarrow{R_{3}} R_{3} \xrightarrow{R_{3}} R_{3}$$

$$R_{3} \xrightarrow{R_{3}} R_{3} \xrightarrow{R_{3}} R_{3}$$

$$R_{4} \xrightarrow{R_{3}} R_{3} \xrightarrow{R_{3}} R_{3}$$

$$R_{5} \xrightarrow{R_{3}} R_{3} \xrightarrow{R_{3}} R_{3}$$

$$R_{5} \xrightarrow{R_{3}} R_{5} \xrightarrow{R_{3}} R_{5}$$

$$R_{5} \xrightarrow{R_{5}} R_{5} \xrightarrow{R_{5}} R_{5}$$

$$R_{5} \xrightarrow{R_{5}} R_{5} \xrightarrow{R_{5}} R_{5}$$

wherein R_1 , R_2 and R_3 independently of one another are hydrogen or C_{1-4} alkyl; X is a C_{6-20} aryl group or alkyl-substituted C_{6-20} aryl group that are derivatives from a dialcohol derivative such as resorcinol, hydroquinol, bisphenol-A and bisphenol-S; and n is $0\sim4$.

Where n is 0, the compound represented in the structural formula (I) is triphenyl phosphate, tricresyl phosphate, trixylenyl phosphate, tri(2,6-dimethyl phenyl) phosphate, tri(2,4-ditertiary butyl phenyl) phosphate, tri(2,6-ditertiary butyl phenyl) phosphate, and the like, and where N is 1, the compounds include resorcinolbis(diphenyl) phosphate, resorcinolbis(2,6-dimethyl phenyl) phosphate, resorcinolbis(2,4-ditertiary butyl phenyl) phosphate, hydroquinolbis(2,6-dimethyl phenyl) phosphate, hydroquinolbis(2,4-ditertiary butyl phenyl) phosphate, and the like. The compounds can be used alone or in combination therewith.

In the present invention, the phosphoric acid ester compound as a flame retardant is used in the amount of 5 to 30 parts by weight per 100 parts by weight of the base resin (A)+(B).

20

5

10

15

Other additives may be contained in the resin composition of the present invention. The additives include an anti-dripping agent, an impact modifier, inorganic filler, a heat stabilizer, an anti-oxidant, a light stabilizer, a pigment, and/or dye. Inorganic filler is such as talc, silica, glass fiber, ceramics, a

carbonate, and a sulphate. The additives are employed in the amount of 0 to 50 parts by weight on the basis of 100 parts by weight of the base resin.

The invention may be better understood by reference to the following examples that are intended for the purpose of illustration and are not to be construed as in any way limiting the scope of the present invention, which is defined in the claims appended hereto. In the following examples, all parts and percentage are by weight unless otherwise indicated.

10 Examples

5

The components to prepare flameproof thermoplastic resin compositions in Examples 1-5 and Comparative Examples 1-5 are as follows:

15 (A) Styrenic resin

(A₁) polystyrene (GPPS)

GPPS by Cheil Industry Co. of Korea (product name: HF-2680) was used.

20

25

30

(A₂) rubber modified styrene-containing resin (HIPS)

Rubber modified polystyrene resin by Cheil Industry Co. of Korea (product name: HG-1760S) was used.

(B) Polyphenylene Ether (PPE)

Poly(2,6-dimethyl-phenyl ether) by Asahi Kasei Co. of Japan (product name: P-402) was used.

(C) Rubber modified polystyrene resin

(C₁) Rubber modified polystyrene resin

50 parts of butadiene rubber latex powder, 48.5 parts of styrene, 1.5 parts of acrylonitrile, and 150 parts of deionized water were blended. To the blend, 1.0 parts of potassium oleate, 0.4 parts of cumenhydroperoxide, 0.2 parts of mercaptan-containing chain transfer agent, 0.4 parts of glucose, 0.01 parts of ferrous sulfate hydrate, and 0.3 parts of sodium pyrophosphate were added. The blend was kept at 75°C for 5 hours to obtain g-ABS latex. To the g-ABS latex, 0.4 parts of sulfuric acid was added, coagulated and dried to obtain rubber modified polystyrene resin (g-ABS) in a powder form.

10

15

. 5

(C₂) Rubber modified polystyrene resin

50 parts of butadiene rubber latex powder, 47.5 parts of styrene, 2.5 parts of acrylonitrile, and 150 parts of deionized water were blended. To the blend, 1.0 parts of potassium oleate, 0.4 parts of cumenhydroperoxide, 0.2 parts of mercaptan-containing chain transfer agent, 0.4 parts of glucose, 0.01 parts of ferrous sulfate hydrate, and 0.3 parts of sodium pyrophosphate were added. The blend was kept at 75°C for 5 hours to obtain g-ABS latex. To the g-ABS latex, 0.4 parts of sulfuric acid was added, coagulated and dried to obtain rubber modified polystyrene resin (g-ABS) in a powder form.

20

25

(C₃) Rubber modified polystyrene resin

50 parts of butadiene rubber latex powder, 46.5 parts of styrene, 3.5 parts of acrylonitrile, and 150 parts of deionized water were blended. To the blend, 1.0 parts of potassium oleate, 0.4 parts of cumenhydroperoxide, 0.2 parts of mercaptan-containing chain transfer agent, 0.4 parts of glucose, 0.01 parts of ferrous sulfate hydrate, and 0.3 parts of sodium pyrophosphate were added. The blend was kept at 75°C for 5 hours to obtain g-ABS latex. To the g-ABS latex, 0.4 parts of sulfuric acid was added, coagulated and dried to obtain rubber modified polystyrene resin (g-ABS) in a powder form.

(D) Phosphoric acid ester compound

Triphenylphosphate(TPP) with a melting point of 48°C was used.

- 5 (E) Rubber modified polystyrene resin (ABS resin)
 - (E₁) Acrylonitrile-Butadiene-Styrene Copolymer Resin (g-ABS resin) 50 parts of butadiene rubber latex powder, 36 parts of styrene, 14 parts of acrylonitrile, and 150 parts of deionized water were blended. To the blend, 1.0 parts of potassium oleate, 0.4 parts of cumenhydroperoxide, 0.2 parts of mercaptan-containing chain transfer agent, 0.4 parts of glucose, 0.01 parts of ferrous sulfate hydrate, and 0.3 parts of sodium pyrophosphate were added. The blend was kept at 75 °C for 5 hours to obtain g-ABS latex. To the g-ABS latex, 0.4 parts of sulfuric acid was added, coagulated and dried to obtain acrylonitrile-butadiene-styrene graft copolymer resin (g-ABS) in a powder form.

(E₂) Butadiene-Styrene Resin (g-BS resin)

50 parts of butadiene rubber latex powder, 50 parts of styrene and 150 parts of deionized water were blended. To the blend, 1.0 parts of potassium oleate, 0.4 parts of cumenhydroperoxide, 0.2 parts of mercaptan-containing chain transfer agent, 0.4 parts of glucose, 0.01 parts of ferrous sulfate hydrate, and 0.3 parts of sodium pyrophosphate were added. The blend was kept at 75°C for 5 hours to obtain g-ABS latex. To the g-ABS latex, 0.4 parts of sulfuric acid was added, coagulated and dried to obtain butadiene-styrene graft copolymer resin (g-BS) in a powder form.

Examples 1~5

10

15

20

25

The components as shown in Table 1 were blended and extruded in the

form of pellets with a twin-screw extruder at $200\sim280\,^{\circ}$ C. The pellets were dried at $80\,^{\circ}$ C for 3 hours and extruded into test specimens in a 6 oz. extruder at molding temperature of $220\sim280\,^{\circ}$ C and barrel temperature of $40\sim80\,^{\circ}$ C, and the resin pellets were molded into test specimens.

5

10

15

Comparative Examples 1~5

The Comparative Examples 1 was conducted in the same manner as in Example 4, except that the rubber modified polystyrene resin (C_1) was not used.

The Comparative Examples 2 was conducted in the same manner as in Example 5, except that the rubber modified polystyrene resin (C_1) was not used.

The Comparative Examples 3 was conducted in the same manner as in Example 1, except that the rubber modified polystyrene resin (C_1) was not used.

The Comparative Examples 4 was conducted in the same manner as in Comparative Examples 3, except that g-ABS resin (E_1) was used.

The Comparative Examples 5 was conducted in the same manner as in Comparative Examples 3, except that g-BS resin (E_2) was used.

Measurement of Physical Properties:

20

(1) Flame retardancy

The flame retardancy was measured in accordance with UL94VB with a thickness of 1/10" and 1/12".

25

(2) Impact strength

Impact strength was measured according to Izod impact strength ASTM D-256 (1/8" notched).

(3) Vicat softening temperature (VST)

Vicat softening temperature was measured in accordance with ASTM D-1525 under load of 1 kg.

(4) Melt flow index

Melt flow index (g/10min) was measured in accordance with ASTM D-1238 at 220℃ and 10 kg load.

(5) Appearance

5

15

Appearance was evaluated by use of a score of test specimens prepared by injecting pellets at 200 °C~280 °C with a 65 degrees viewing angle. The pellets was prepared from a rectangular plate mold of 50mm × 200mm × 2mm with a gate having a diameter of 2 mm which was 30 mm away from a central portion of one of the ends thereof.

Table 1

		Examples				Comparative Examples					
	•	1	2	3	4	5	1	2	3	4	5
(4)	(A ₁) GPPS	35	35	35	70	-	70	-	35	35	35
(A) –	(A ₂) HIPS	35	35	35	-	70	-	70	35	35	35
(B) PPE resin		30	30	30	30	30	30	30	30	30	30
	(C ₁)	20	-	-	20	20	-	-			-
(C)	(C ₂)	-	20			-	-	-	_	_	-
-	(C ₃)	_	-	20	•	_	-			-	-
(D) Phosphoric acid ester		⁻ 15	15	15	15	15	15	15	15	15	15
(IE)	(E ₁)	-	-	_	_	-	_	••		20	-
(E) -	(E ₂)	-	-	_	-	_	-	-	-		20
Izod Ii	mpact Strength (1/8")	29	30	24	23	33	8	11	9	8	23
VST Melt Flow Index UL 94(1/10") UL 94(1/12")		95	95	95	96	93	95	96	89	98	93
		31	30	30	33	31	35	32	33	24	25
		5V	5V	5V	5V	5V	5V	FAIL	5V	FAIL	FAIL
		5V	5V	5V	5V	5V	FAIL	FAIL	FAIL	FAIL	FAIL
Aver com (S	rage of overall abustion time SEC,1/10")	36	34	36	34	38	49	67	55	_	-
	ppearance	90	90	88	94	90	95	60	70	86	

As shown in the table 1, the resin composition of the present invention

had good impact strength and appearance due to rubber modified polystyrene
resin (C) Further, flame retardancy was also enhanced. Comparative Examples
1~5 not employing the component (C) showed much lower impact strength,
appearance and flame retardancy in comparison with the Examples.

The present invention can be easily carried out by an ordinary skilled person in the art. Many modifications and changes may be deemed to be with the scope of the present invention as defined in the following claims.

What is claimed is:

5

10

15

25

1. A thermoplastic flame retardant resin composition comprising:

- (A) about 40 to 95 parts by weight of a styrenic resin;
- (B) about 5 to 60 parts by weight of a polyphenylene ether;
- (C) about 0.1 to 40 parts by weight of a rubber modified polystyrene resin containing about 40 to 65 % by weight of a rubber and about 0.1 to 8 % by weight of acrylonitrile in the polystyrene resin excluding rubber based on 100 parts by weight of the sum of (A) and (B); and
- (D) about 5 to 30 parts by weight of an aromatic phosphoric acid ester compound based on 100 parts by weight of the sum of (A) and (B).
- 2. The thermoplastic flame retardant resin composition as defined in claim 1, wherein said styrenic resin (A) is selected from the group consisting of polystyrene resin, rubber modified polystyrene resin and a mixture thereof.
- 3. The thermoplastic flame retardant resin composition as defined in claim 2, wherein said styrenic resin (A) is polystyrene.
- 4. The thermoplastic flame retardant resin composition as defined in claim 2, wherein said styrenic resin (A) is a rubber modified polystyrene resin.
 - 5. The thermoplastic flame retardant resin composition as defined in claim 1, wherein said rubber modified polystyrene resin (C) further comprises less than 40 parts by weight of a monomer selected from the group consisting of acrylic acid, methacrylate, maleic anhydride, and N-substituted maleimide, per 100 parts by weight of said rubber modified polystyrene resin.
- 6. The thermoplastic flame retardant resin composition as defined in claim 1, wherein said rubber modified polystyrene resin (C) comprises 0.1 to 5 % by weight

of an acrylonitrile in the polystyrene resin excluding rubber.

5

7. The thermoplastic flame retardant resin composition as defined in claim 1, wherein said aromatic phosphoric acid ester (D) is represented by following formula (I):

$$R_{2} \xrightarrow{R_{1}} O \xrightarrow{P} O \xrightarrow{R_{2}} R_{3} \xrightarrow{R_{1}} R_{3} \xrightarrow{R_{2}} R_{2}$$

$$R_{2} \xrightarrow{R_{3}} R_{1} \xrightarrow{R_{2}} R_{3}$$

$$R_{2} \xrightarrow{R_{2}} R_{2}$$

$$(I)$$

wherein R₁, R₂ and R₃ independently of one another are hydrogen or C₁₋₄
10 alkyl; X is a C₆₋₂₀ aryl group or alkyl-substituted C₆₋₂₀ aryl group that are
derivatives from a dialcohol derivative such as resorcinol, hydroquinol,
bisphenol-A and bisphenol-S; and n is 0~4.

8. The thermoplastic flame retardant resin composition as defined in claim 1,
wherein said resin composition further comprises an anti-dripping agent, an impact
modifier, an inorganic filler, a heat stabilizer, an anti-oxidants, a light stabilizer, a
pigment, and/or dye.

INTERNATIONAL SEARCH REPORT

PCT/KR03/00749

A. CLASSIFICATION OF SUBJECT MATTER

IPC7 C08L 25/06, C08L 71/02, C08L 55/02, C08K 5/521, C08L 25/10

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC7: C08L 25/06, C08L 71/02, C08L 55/02, C08L 5/521, C08L 25/10

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched Korean Patents and applications for inventions since 1975

Electronic data base consulted during the intertnational search (name of data base and, where practicable, search terms used) KIPASS, JAPIO, USPTO

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
Y	US 4,599,380 A (ASAHI KASEI KOGYO K.K.) 08 JULY 1986 * see the whole document.	1-8
Y	KR 2001-0107434 A (CHEIL INDUSTRIES INC.) 07 DECEMBER 2001 * see the whole document.	1-8
A	EP 359469 A2 (ASAHI KASEI KOGYO K.K.) 21 MARCH 1990 * see the whole document.	1-8
A	KR 2001-0055739 A (CHEIL INDUSTRIES INC.) 04 JULY 2001 * see the whole document.	1-8
A .	JP 09-183886 A (ASAHI CHEMICAL IND.) 15 JULY 1997 * see the whole document.	1-8
A	JP 09-137032 A (SHINNITSUTETSU KAGAKU KK) 27 MAY 1997 * see the whole document.	1-8
A	JP 08-259796 A (MITSUBISHII CHEMICAL CO) 08 OCTOVER 1996 * see the whole document.	1-8

ı	i	Further	documents	are	listed	in t	the	continuation	ı of	Box C.	
---	---	---------	-----------	-----	--------	------	-----	--------------	------	--------	--

X See patent family annex.

- Special categories of cited documents:
- "A" document defining the general state of the art which is not considered to be of particular relevance
- "E" earlier application or patent but published on or after the international
- "L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of citation or other special reason (as specified)
- "O" document referring to an oral disclosure, use, exhibition or other
- "P" document published prior to the international filing date but later than the priority date claimed
- "T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention
- "X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone
- "Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art
- "&" document member of the same patent family

Date of the actual completion of the international search 07 JULY 2003 (07.07.2003)

Date of mailing of the international search report

08 JULY 2003 (08.07.2003)

Name and mailing address of the ISA/KR

S P

Korean Intellectual Property Office 920 Dunsan-dong, Seo-gu, Daejeon 302-701, Republic of Korea

Facsimile No. 82-42-472-7140

Authorized officer

LEE, Ha Yeon

Telephone No. 82-42-481-5537



INTERNATIONAL SEARCH REPORT

Information on patent family members

International application No. PCT/KR03/00749

Patent document cited in search report	Publication date	Patent family member(s)	Publication date
KR2001-0107434A	07.12.2001	NONE	
US4599380A	08.07.1986	EP0089149A1 JP58154754A	21.09.1983 14.09.1983
EP0359469A2	21.03.1990	CA1334695A1 CN1042371A DE68924748B1 KR9303693B1 US4966814A	07.03.1995 23.05.1990 14.12.1995 08.05.1993 30.10.1990
KR2001-0055739A	04.07.2001	NONE	
JP09-183886A	15.07.1997	NONE	
JP09-137032A	27.05.1997	NONE	
JP08-259796A	08.10.1996	NONE	